

PART NUMBER

UA733M^BCA-ROC

Rochester Electronics

Manufactured Components

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All re-creations are done with the approval of the Original Component Manufacturer. (OCM)

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceeds the OCM data sheet.

Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-38535
 - Class Q Military
 - Class V Space Level

Qualified Suppliers List of Distributors (QSLD)

- Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OCM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

The μ A733M is obsolete
and no longer supplied.

μ A733C, μ A733M DIFFERENTIAL VIDEO AMPLIFIERS

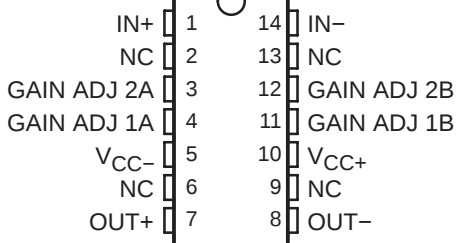
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- 200-MHz Bandwidth
- 250-k Ω Input Resistance
- Selectable Nominal Amplification of 10, 100, or 400
- No Frequency Compensation Required

μ A733C . . . D, N, OR NS PACKAGE

μ A733M . . . J PACKAGE

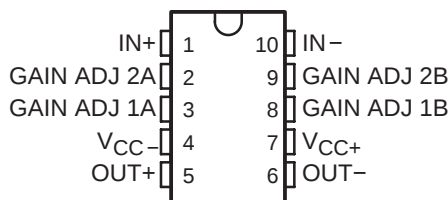
(TOP VIEW)



NC — No internal connection

μ A733M . . . U PACKAGE

(TOP VIEW)



description/ordering information

The μ A733 is a monolithic two-stage video amplifier with differential inputs and differential outputs. Internal series-shunt feedback provides wide bandwidth, low phase distortion, and excellent gain stability. Emitter-follower outputs enable the device to drive capacitive loads, and all stages are current-source biased to obtain high common-mode and supply-voltage rejection ratios.

Fixed differential amplification of 10 V/V, 100 V/V, or 400 V/V may be selected without external components, or amplification may be adjusted from 10 V/V to 400 V/V by the use of a single external resistor connected between 1A and 1B. No external frequency-compensating components are required for any gain option.

The device is particularly useful in magnetic-tape or disc-file systems using phase or NRZ encoding and in high-speed thin-film or plated-wire memories. Other applications include general-purpose video and pulse amplifiers where wide bandwidth, low phase shift, and excellent gain stability are required.

The μ A733C is characterized for operation from 0°C to 70°C; the μ A733M is characterized for operation over the full military temperature range of –55°C to 125°C.

ORDERING INFORMATION

TA	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	P-DIP (N)	Tube of 25	UA733CN	UA733CN
	SOIC (D)	Tube of 50	UA733CD	UA733C
		Reel of 2500	UA733CDR	
	SOP (NS)	Reel of 2000	UA733CNSR	UA733

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

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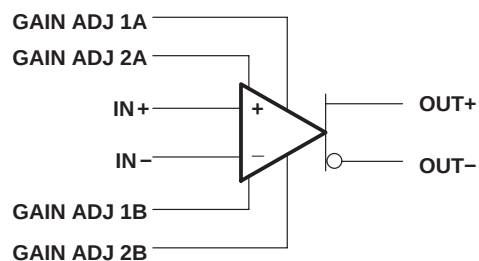
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μA733C, μA733M **DIFFERENTIAL VIDEO AMPLIFIERS**

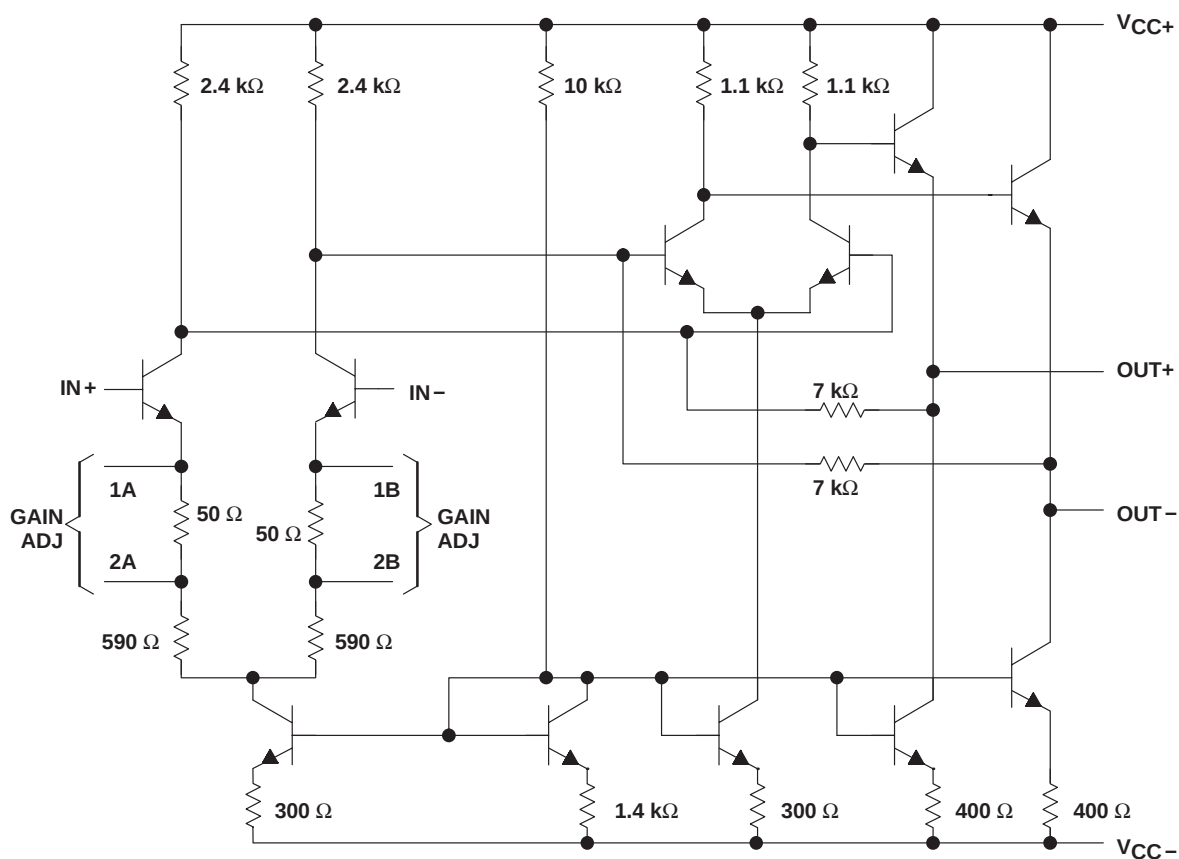
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The μA733M is obsolete
 and no longer supplied.

symbol



schematic



Component values shown are nominal.

The μ A733M is obsolete
and no longer supplied.

μ A733C, μ A733M DIFFERENTIAL VIDEO AMPLIFIERS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

		μ A733C	μ A733M	UNIT
Supply voltage V_{CC+} (see Note 1)		8	8	V
Supply voltage V_{CC-} (see Note 1)		– 8	– 8	V
Differential input voltage		± 5	± 5	V
Common-mode input voltage		± 6	± 6	V
Output current		10	10	mA
Continuous total power dissipation		See Dissipation Rating Table		
Package thermal impedance, θ_{JA} (see Notes 2 and 3)	D package	86		$^{\circ}\text{C/W}$
	N package	80		
	NS package	76		
Maximum junction temperature, T_J		150		$^{\circ}\text{C}$
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds	J or U package		300	$^{\circ}\text{C}$
Storage temperature range, T_{Stg}		– 65 to 150	– 65 to 150	$^{\circ}\text{C}$

[†] Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions beyond those indicated in the recommended operating conditions section of this specification is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. All voltage values, except differential input voltages, are with respect to the midpoint between V_{CC+} and V_{CC-} .
 2. Maximum power dissipation is a function of $T_J(\text{max})$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $PD = (T_J(\text{max}) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
 3. The package thermal impedance is calculated in accordance with JESD 51-7.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25^{\circ}\text{C}$ POWER RATING	DERATING FACTOR	DERATE ABOVE T_A	$T_A = 70^{\circ}\text{C}$ POWER RATING	$T_A = 125^{\circ}\text{C}$ POWER RATING
J (μ A733M)	500 mW	11.0 mW/ $^{\circ}\text{C}$	104°C	500 mW	269 mW

μA733C, μA733M **DIFFERENTIAL VIDEO AMPLIFIERS**

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electrical characteristics, $V_{CC\pm} = \pm 6\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER		FIGURE	TEST CONDITIONS	GAIN OPTION†	μA733C			μA733M			UNIT
					MIN	TYP	MAX	MIN	TYP	MAX	
A _{VD}	Large-signal differential voltage amplification	1	V _{OD} = 1 V	1	250	400	600	300	400	500	V/V
				2	80	100	120	90	100	110	
				3	8	10	12	9	10	11	
BW	Bandwidth	2	R _S = 50 Ω	1	50			50			MHz
				2	90			90			
				3	200			200			
I _{IO}	Input offset current			Any	0.4 5			0.4 3			μA
I _{IB}	Input bias current			Any	9 30			9 20			μA
V _{ICR}	Common-mode input voltage range	1		Any	±1			±1			V
V _{OC}	Common-mode output voltage	1		Any	2.4	2.9	3.4	2.4	2.9	3.4	V
V _{OO}	Output offset voltage	1		1	0.6 1.5			0.6 1.5			V
				2 & 3	0.35 1.5			0.35 1			
V _{OPP}	Maximum peak- to-peak output voltage swing	1		Any	3	4.7		3	4.7		V
r _i	Input resistance	3	V _{OD} ≤ 1 V	1	4			4			kΩ
				2	10	24		20	24		
				3	250			250			
r _o	Output resistance				20			20			Ω
C _i	Input capacitance	3	V _{OD} ≤ 1 V	2	2			2			pF
CMRR	Common-mode rejection ration	4	V _{IC} = ±1 V, f ≤ 100 kHz	2	60	86		60	86		dB
			V _{IC} = ±1 V, f = 5 MHz	2	70			70			
k _{SVR}	Supply voltage rejection ratio (ΔV _{CC} /ΔV _{IO})	1	ΔV _{CC} ± = ±0.5 V	2	50	70		50	70		dB
V _n	Broadband equivalent input noise voltage	5	BW = 1 kHz to 10 MHz	Any	12			12			μV
t _{pd}	Propagation delay time	2	R _S = 50 Ω, Output voltage step = 1 V	1	7.5			7.5			ns
				2	6.0 10			6.0 10			
				3	3.6			3.6			
t _r	Rise time	2	R _S = 50 Ω, Output voltage step = 1 V	1	10.5			10.5			ns
				2	4.5 12			4.5 10			
				3	2.5			2.5			
I _{sink(max)}	Maximum output sink current			Any	2.5	3.6		2.5	3.6		mA
I _{CC}	Supply current		No load, No signal	Any	16 24			16 24			mA

† The gain option is selected as follows:

Gain Option 1: Gain-adjust pin 1A is connected to pin 1B, and pins 2A and 2B are open.

Gain Option 2: Gain-adjust pin 1A and pin 1B are open, pin 2A is connected to pin 2B.

Gain Option 3: All four gain-adjust pins are open.



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μ A733C, μ A733M DIFFERENTIAL VIDEO AMPLIFIERS

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electrical characteristics, $V_{CC\pm} = \pm 6\text{ V}$, $T_A = 0^\circ\text{C}$ to 70°C for μ A733C, -55°C to 125°C for μ A733M

PARAMETER	FIGURE	TEST CONDITIONS	GAIN OPTION†	μ A733C		μ A733M		UNIT
				MIN	MAX	MIN	MAX	
A_{VD}	Large-signal differential voltage amplification	1	$V_{OD} = 1\text{ V}$	1	250 600	200 600		V/V
				2	80 120	80 120		
				3	8 12	8 12		
I_{IO}	Input offset current		Any		6		5	μA
I_{IB}	Input bias current		Any		40		40	μA
V_{ICR}	Common-mode input voltage range	1	Any	± 1		± 1		V
V_{OO}	Output offset voltage	1	1		1.5		1.5	V
			2 & 3		1.5		1.2	
V_{OPP}	Maximum peak-to-peak output voltage swing	1	Any		2.8		2.5	V
r_i	Input resistance	3	$V_{OD} \leq 1\text{ V}$	2	8		8	$\text{k}\Omega$
CMRR	Common-mode rejection ratio	4	$V_{IC} = +1\text{ V}$, $f \leq 100\text{ kHz}$	2	50		50	dB
k_{SVR}	Supply voltage rejection ratio ($\Delta V_{CC}/\Delta V_{IO}$)	1	$\Delta V_{CC\pm} = \pm 0.5\text{ V}$	2	50		50	dB
$I_{\text{sink(max)}}$	Maximum output sink current		Any		2.5		2.2	mA
I_{CC}	Supply current		No load, No signal	Any		27		27 mA

† The gain option is selected as follows:

Gain Option 1: Gain-adjust pin 1A is connected to pin 1B, and pins 2A and 2B are open.

Gain Option 2: Gain-adjust pin 1A and pin 1B are open, pin 2A is connected to pin 2B.

Gain Option 3: All four gain-adjust pins are open.



PARAMETER MEASUREMENT INFORMATION

test circuits

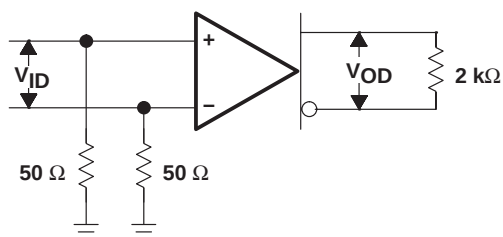


Figure 1

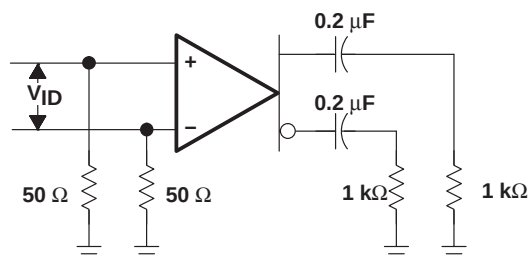


Figure 2

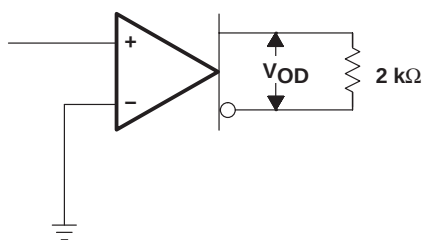


Figure 3

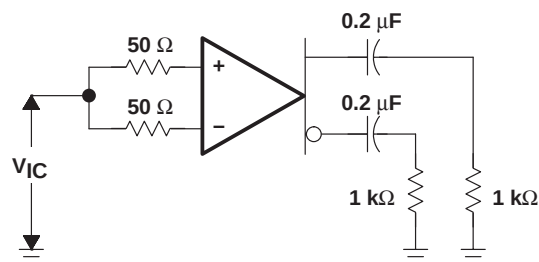


Figure 4

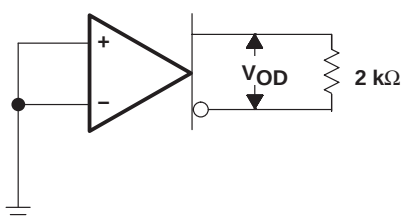
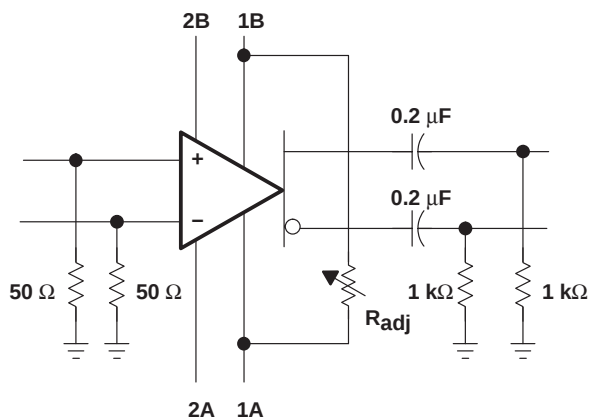


Figure 5



VOLTAGE AMPLIFICATION ADJUSTMENT

Figure 6

TYPICAL CHARACTERISTICS

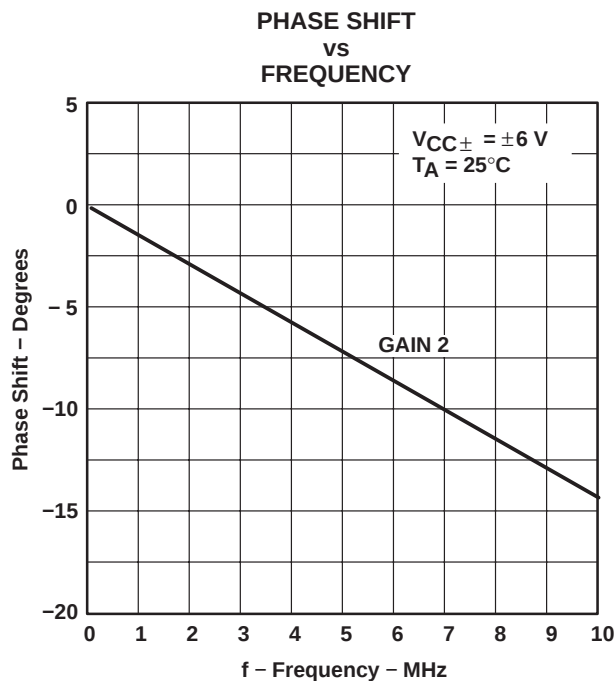


Figure 7

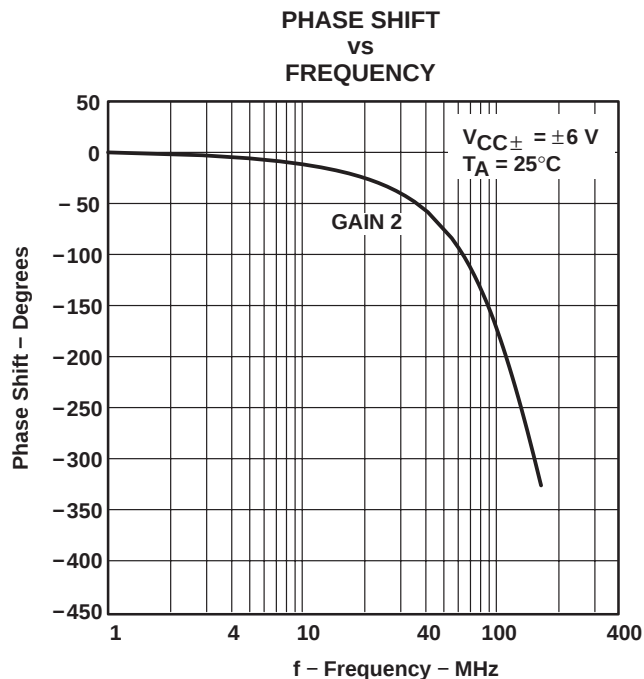


Figure 8

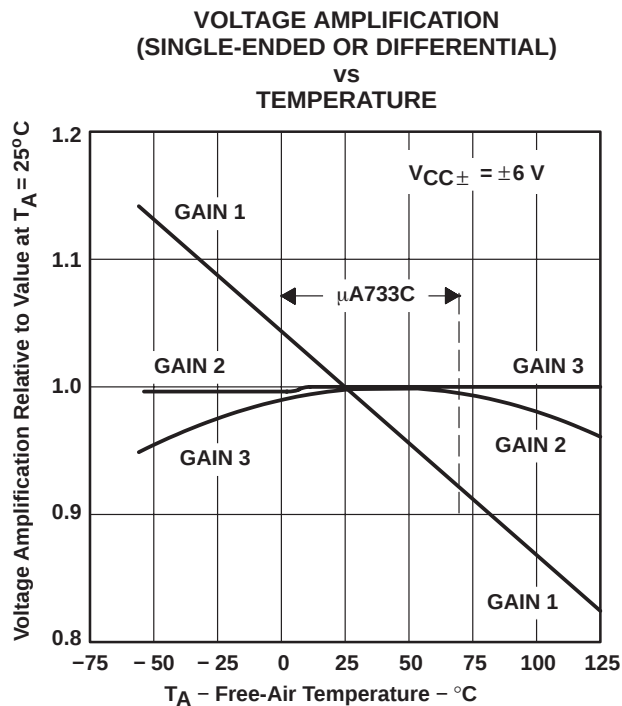


Figure 9

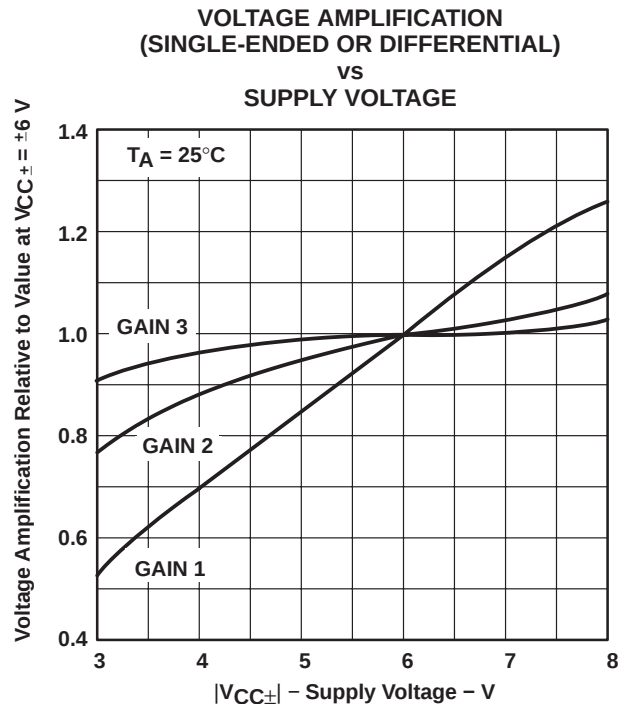


Figure 10

TYPICAL CHARACTERISTICS

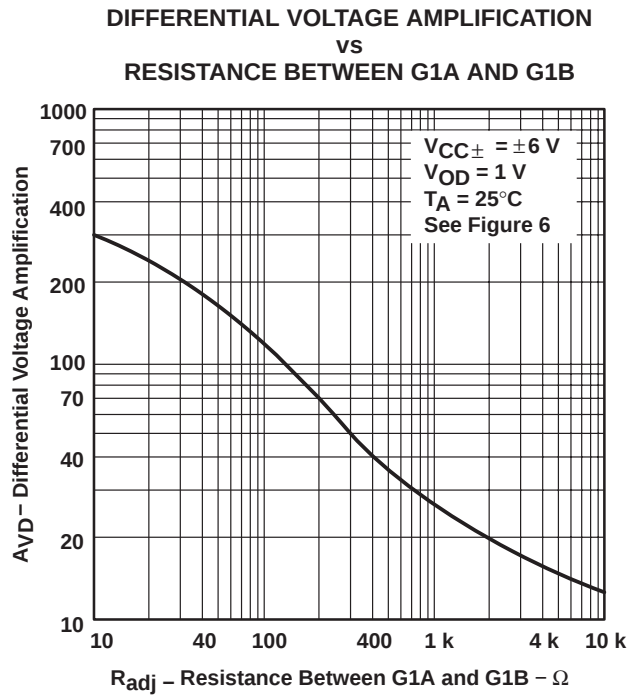


Figure 11

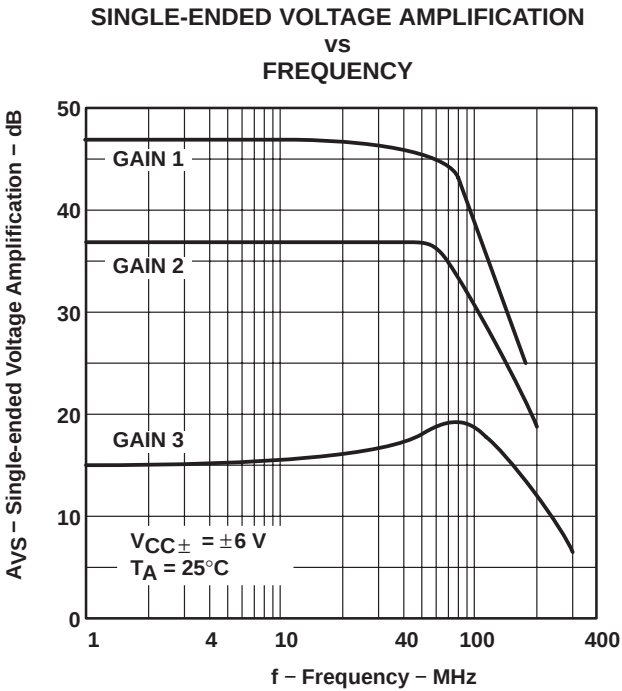


Figure 12

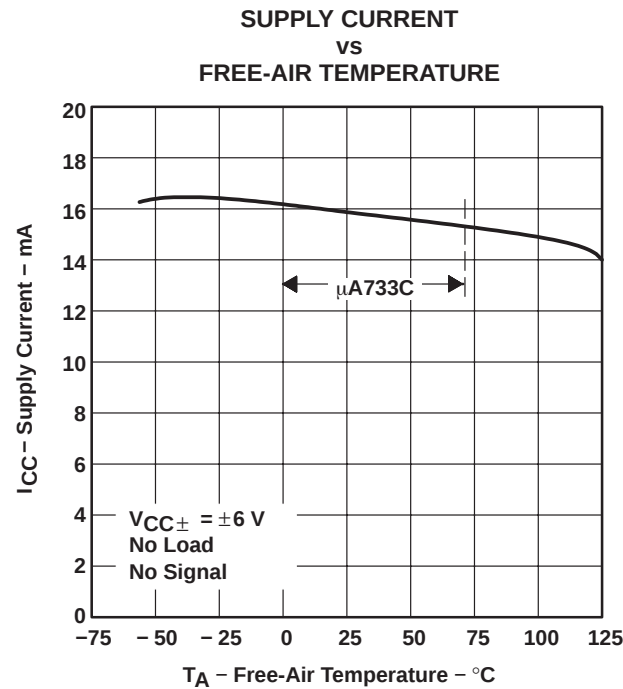


Figure 13

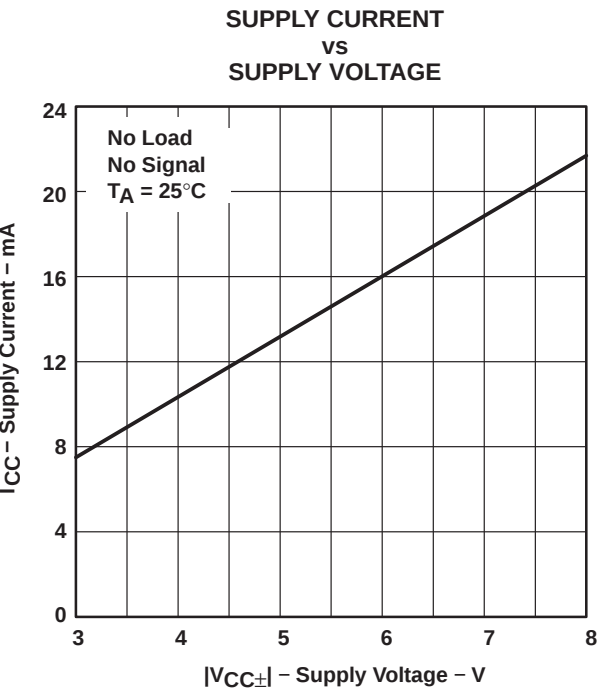


Figure 14

TYPICAL CHARACTERISTICS

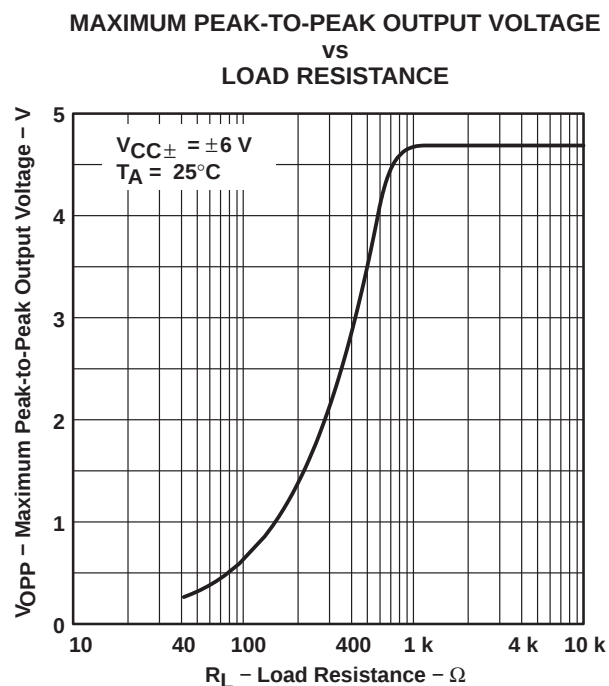


Figure 15

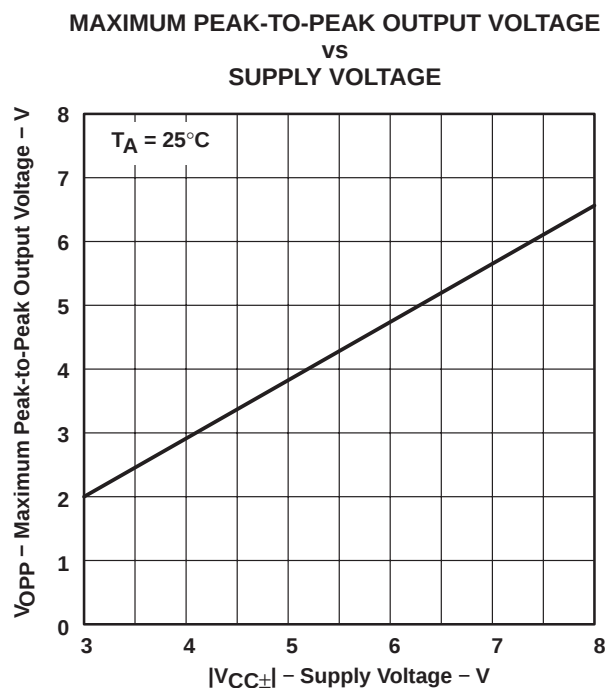


Figure 16

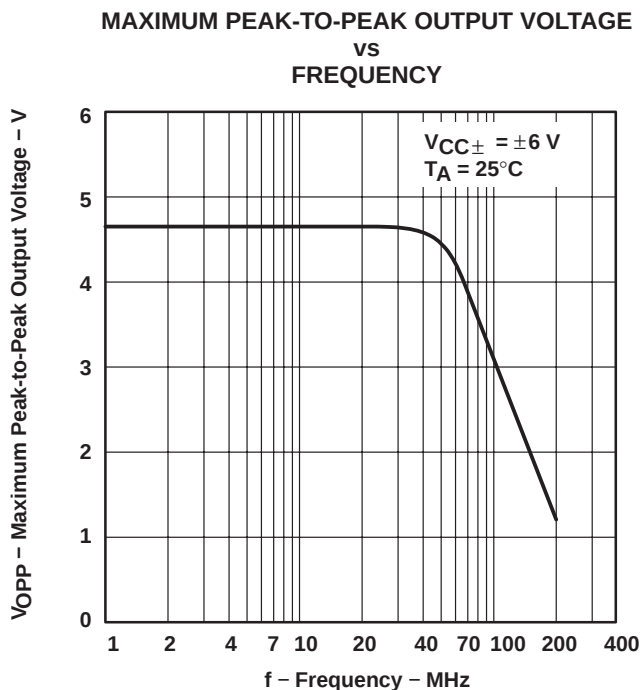


Figure 17

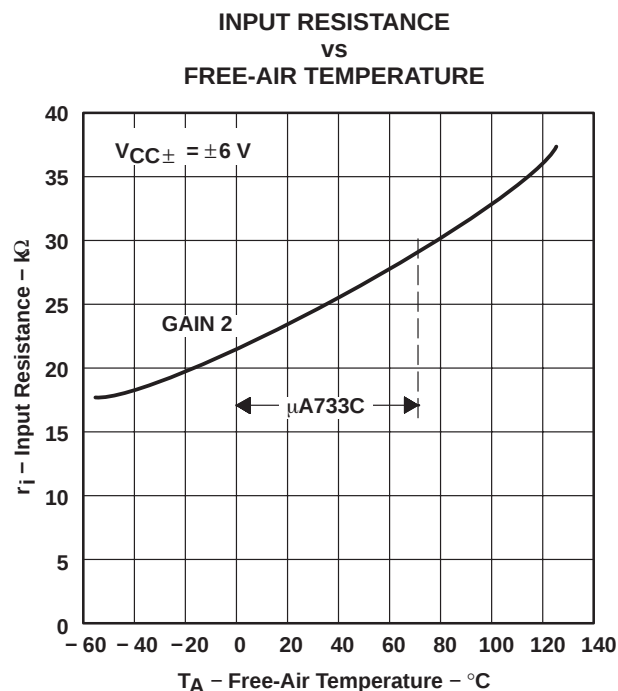


Figure 18

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
UA733CD	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	UA733C	Samples
UA733CDR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	UA733C	Samples
UA733CN	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	UA733CN	Samples
UA733CNSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	UA733	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
UA733CDR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
UA733CNSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
UA733CDR	SOIC	D	14	2500	356.0	356.0	35.0
UA733CNSR	SO	NS	14	2000	356.0	356.0	35.0

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
UA733CD	D	SOIC	14	50	506.6	8	3940	4.32
UA733CN	N	PDIP	14	25	506	13.97	11230	4.32

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

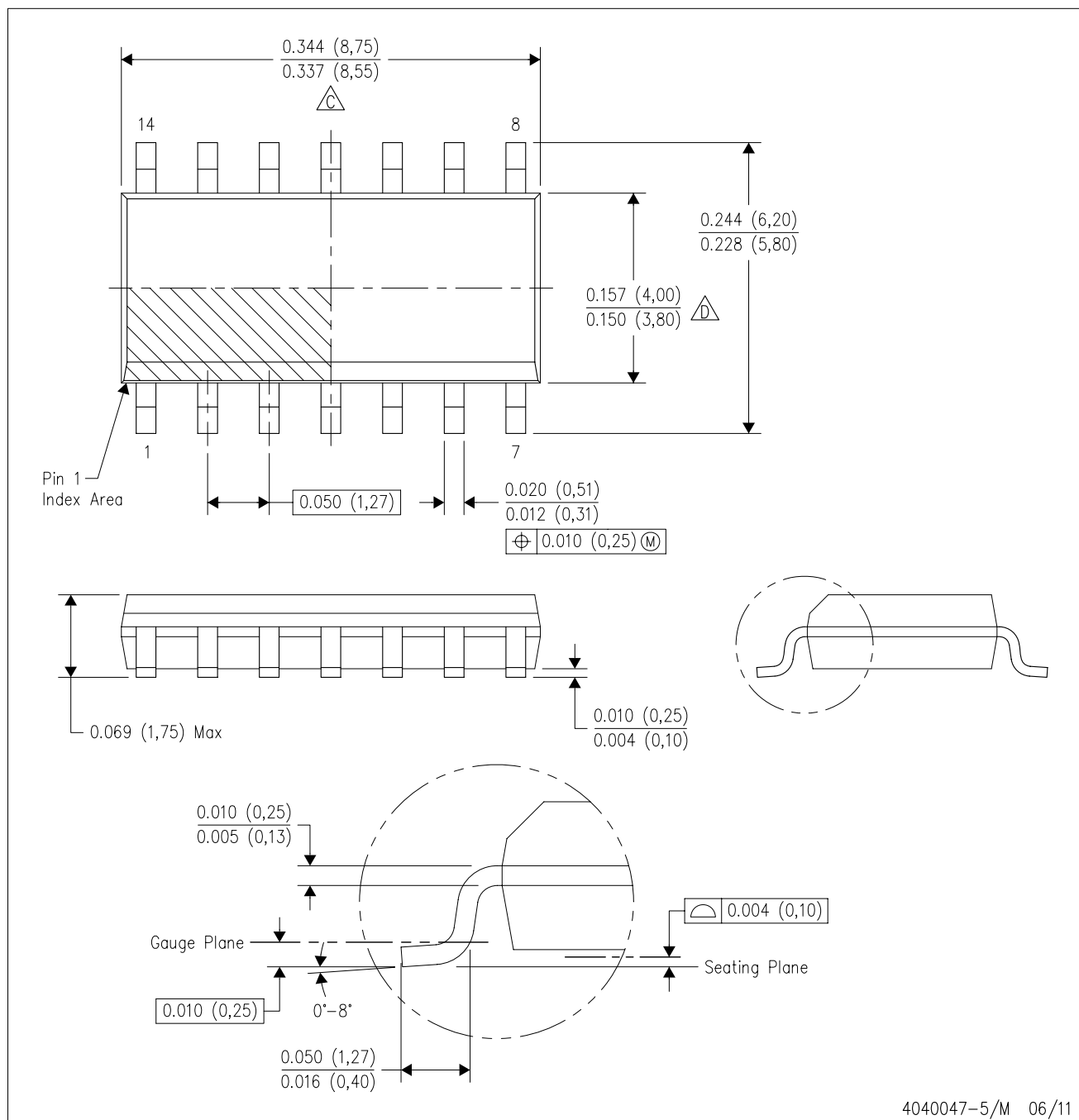
14-PINS SHOWN



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
D Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
E. Reference JEDEC MS-012 variation AB.

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Publication IPC-7351 is recommended for alternate designs.
 - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



4040049/E 12/2002

NOTES:

- A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 The 20 pin end lead shoulder width is a vendor option, either half or full width.

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